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Details

Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	5MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	22
Program Memory Size	2KB (2K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.173", 4.40mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0223hj005eg

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CPU and Peripheral Overview

The eZ8 CPU, Zilog's latest 8-bit central processing unit (CPU), meets the continuing demand for faster and code-efficient microcontrollers. The eZ8 CPU executes a superset of the original Z8 instruction set. The eZ8 CPU features include:

- Direct register-to-register architecture allows each register to function as an accumulator, improving execution time and decreasing the required program memory
- Software stack allows much greater depth in subroutine calls and interrupts than hardware stacks
- Compatible with existing Z8 code
- Expanded internal Register File allows access of up to 4 KB
- New instructions improve execution efficiency for code developed using higher-level programming languages, including C
- Pipelined instruction fetch and execution
- New instructions for improved performance including BIT, BSWAP, BTJ, CPC, LDC, LDCI, LEA, MULT, and SRL
- New instructions support 12-bit linear addressing of the Register File
- Up to 10 MIPS operation
- C-Compiler friendly
- 2 to 9 clock cycles per instruction

For more information about the eZ8 CPU, refer to the [eZ8 CPU Core User Manual \(UM0128\)](#) available for download at www.zilog.com.

General-Purpose I/O

F0823 Series features 6 to 24 port pins (Ports A–C) for general-purpose I/O (GPIO). The number of GPIO pins available is a function of package. Each pin is individually programmable. 5V-tolerant input pins are available on all I/Os on 8-pin devices, most I/Os on other package types.

Flash Controller

The Flash Controller programs and erases Flash memory. The Flash Controller supports protection against accidental program and erasure, as well as factory serialization and read protection.

Pin Description

Z8 Encore! XP F0823 Series products are available in a variety of package styles and pin configurations. This chapter describes the signals and pin configurations available for each of the package styles. For information about physical package specifications, see the [Packaging](#) chapter on page 210.

Available Packages

Table 2 lists the package styles that are available for each device in the F0823 Series product line.

Table 2. F0823 Series Package Options

Part Number	ADC	8-pin PDIP	8-pin SOIC	20-pin PDIP	20-pin SOIC	20-pin SSOP	28-pin PDIP	28-pin SOIC	28-pin SSOP	8-pin QFN/MLF-S
Z8F0823	Yes	X	X	X	X	X	X	X	X	X
Z8F0813	No	X	X	X	X	X	X	X	X	X
Z8F0423	Yes	X	X	X	X	X	X	X	X	X
Z8F0413	No	X	X	X	X	X	X	X	X	X
Z8F0223	Yes	X	X	X	X	X	X	X	X	X
Z8F0213	No	X	X	X	X	X	X	X	X	X
Z8F0123	Yes	X	X	X	X	X	X	X	X	X
Z8F0113	No	X	X	X	X	X	X	X	X	X

Pin Configurations

Figures 2 through 4 display the pin configurations for all packages available in the F0823 Series. For description of signals, see Table 3. The analog input alternate functions (ANAx) are not available on the Z8F0x13 devices. The analog supply pins (AV_{DD} and AV_{SS}) are also not available on these parts, and are replaced by PB6 and PB7.

At reset, all pins of Ports A, B, and C default to an input state. In addition, any alternate functionality is not enabled, so the pins function as general-purpose input ports until programmed otherwise.

The pin configurations listed are preliminary and subject to change based on manufacturing limitations.

Table 3. Signal Descriptions (Continued)

Signal Mnemonic	I/O	Description
COUT	O	Comparator Output. This is the output of the comparator.
Analog		
ANA[7:0]	I	Analog port. These signals are used as inputs to the ADC. The ANA0, ANA1, and ANA2 pins can also access the inputs and output of the integrated transimpedance amplifier.
VREF	I/O	Analog-to-Digital Converter reference voltage input.
Clock Input		
CLKIN	I	Clock Input Signal. This pin can be used to input a TTL-level signal to be used as the system clock.
LED Drivers		
LED	O	Direct LED drive capability. All port C pins have the capability to drive an LED without any other external components. These pins have programmable drive strengths set by the GPIO block.
On-Chip Debugger		
DBG	I/O	Debug. This signal is the control and data input and output to and from the OCD. Caution: The DBG pin is open-drain and requires an external pull-up resistor to ensure proper operation.
Reset		
RESET	I/O	RESET. Generates a reset when asserted (driven Low). Also serves as a reset indicator; the Z8 Encore! XP forces this pin Low when in reset. This pin is open-drain and features an enabled internal pull-up resistor.
Power Supply		
V _{DD}	I	Digital Power Supply.
AV _{DD} ²	I	Analog Power Supply.
V _{SS}	I	Digital Ground.
AV _{SS}	I	Analog Ground.

Notes:

1. PB6 and PB7 are only available in 28-pin packages without ADC. In 28-pin packages with ADC, they are replaced by AV_{DD} and AV_{SS}.
2. The AV_{DD} and AV_{SS} signals are available only in 28-pin packages with ADC. They are replaced by PB6 and PB7 on 28-pin packages without ADC.

Reset and Stop Mode Recovery

The Reset Controller within the Z8 Encore! XP F0823 Series controls Reset and Stop Mode Recovery operation and provides indication of low supply voltage conditions. In typical operation, the following events cause a Reset:

- Power-On Reset (POR)
- Voltage Brown-Out (VBO)
- Watchdog Timer time-out (when configured by the WDT_RES Flash Option Bit to initiate a reset)
- External $\overline{\text{RESET}}$ pin assertion (when the alternate RESET function is enabled by the GPIO register)
- On-chip Debugger initiated Reset (OCDCTL[0] set to 1)

When the device is in STOP Mode, a Stop Mode Recovery is initiated by either of the following:

- Watchdog Timer time-out
- GPIO port input pin transition on an enabled Stop Mode Recovery source

The VBO circuitry on the device performs the following function:

- Generates the VBO reset when the supply voltage drops below a minimum safe level

Reset Types

F0823 Series MCUs provide several different types of Reset operations. Stop Mode Recovery is considered a form of Reset. Table 9 lists the types of Reset and their operating characteristics. The duration of a System Reset is longer if the external crystal oscillator is enabled by the Flash option bits; this configuration allows additional time for oscillator startup.

Table 9. Reset and Stop Mode Recovery Characteristics and Latency

Reset Characteristics and Latency			
Reset Type	Control Registers	eZ8 CPU	Reset Latency (Delay)
System Reset	Reset (as applicable)	Reset	66 Internal Precision Oscillator Cycles
Stop Mode Recovery	Unaffected, except WDT_CTL and OSC_CTL registers	Reset	66 Internal Precision Oscillator Cycles + IPO startup time

Table 17. Port Alternate Function Mapping (Non 8-Pin Parts) (Continued)

Port	Pin	Mnemonic	Alternate Function Description	Alternate Function Set Register AFS1
Port C ⁴	PC0	Reserved		AFS1[0]: 0
		ANA4/CINP	ADC or Comparator Input	AFS1[0]: 1
	PC1	Reserved		AFS1[1]: 0
		ANA5/CINN	ADC or Comparator Input	AFS1[1]: 1
	PC2	Reserved		AFS1[2]: 0
		ANA6/V _{REF} ⁶	ADC Analog Input or ADC Voltage Reference	AFS1[2]: 1
	PC3	COUT	Comparator Output	AFS1[3]: 0
		Reserved		AFS1[3]: 1
	PC4	Reserved		AFS1[4]: 0
				AFS1[4]: 1
	PC5	Reserved		AFS1[5]: 0
				AFS1[5]: 1
	PC6	Reserved		AFS1[6]: 0
				AFS1[6]: 1
	PC7	Reserved		AFS1[7]: 0
				AFS1[7]: 1

Notes:

1. Because there is only a single alternate function for each Port A pin, the Alternate Function Set registers are not implemented for Port A. Enabling alternate function selections as described in the [Port A–C Alternate Function Subregisters](#) section on page 43 automatically enables the associated alternate function.
2. Whether PA0/PA6 take on the timer input or timer output complement function depends on the timer configuration as described in the [Timer Pin Signal Operation](#) section on page 83.
3. Because there are at most two choices of alternate function for any pin of Port B, the Alternate Function Set register AFS2 is implemented but not used to select the function. Also, alternate function selection as described in the [Port A–C Alternate Function Subregisters](#) section on page 43 must also be enabled.
4. V_{REF} is available on PB5 in 28-pin products only.
5. Because there are at most two choices of alternate function for any pin of Port C, the Alternate Function Set register AFS2 is implemented but not used to select the function. Also, Alternate Function selection as described in the [Port A–C Alternate Function Subregisters](#) section on page 43 must also be enabled.
6. V_{REF} is available on PC2 in 20-pin parts only.

Direct LED Drive

The Port C pins provide a current sinked output capable of driving an LED without requiring an external resistor. The output sinks current at programmable levels of 3mA, 7mA, 13mA, and 20mA. This mode is enabled through the LED control registers. The LED Drive Enable (LEDEN) register turns on the drivers. The LED Drive Level (LEDLVLH and LEDLVLL) registers select the sink current.

Port A–C Alternate Function Set 1 Subregisters

The Port A–C Alternate Function Set1 Subregister (Table 28) is accessed through the Port A–C Control Register by writing 07H to the Port A–C Address Register. The Alternate Function Set 1 subregisters selects the alternate function available at a port pin. Alternate Functions selected by setting or clearing bits of this register are defined in “**GPIO Alternate Functions**” on page 34.

► **Note:** Alternate function selection on port pins must also be enabled as described in the Port A–C Alternate Function Subregisters section on page 43.

Table 28. Port A–C Alternate Function Set 1 Subregisters (PAFS1x)

Bit	7	6	5	4	3	2	1	0
Field	PAFS17	PAFS16	PAFS15	PAFS14	PAFS13	PAFS12	PAFS11	PAFS10
RESET	00H (all ports of 20/28 pin devices); 04H (Port A of 8-pin device)							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	If 07H in Port A–C Address Register, accessible through the Port A–C Control Register							

Bit	Description
[7:0]	Port Alternate Function Set to 1
PAFS1x	0 = Port Alternate Function selected as defined in Table 15 (see the <u>GPIO Alternate Functions</u> section on page 34). 1 = Port Alternate Function selected as defined in Table 15 (see the <u>GPIO Alternate Functions</u> section on page 34).

Note: x indicates the specific GPIO port pin number (7–0).

Port A–C Input Data Registers

Reading from the Port A–C Input Data registers (Table 30) returns the sampled values from the corresponding port pins. The Port A–C Input Data registers are read-only. The value returned for any unused ports is 0. Unused ports include those missing on the 8- and 28-pin packages, as well as those missing on the ADC-enabled 28-pin packages.

Table 30. Port A–C Input Data Registers (PxIN)

Bit	7	6	5	4	3	2	1	0
Field	PIN7	PIN6	PIN5	PIN4	PIN3	PIN2	PIN1	PIN0
RESET	X	X	X	X	X	X	X	X
R/W	R	R	R	R	R	R	R	R
Address	FD2H, FD6H, FDAH							

Bit	Description
[7:0] PxIN	Port Input Data Sampled data from the corresponding port pin input. 0 = Input data is logical 0 (Low). 1 = Input data is logical 1 (High).

Note: x indicates the specific GPIO port pin number (7–0).

- Set or clear CTSE to enable or disable control from the remote receiver using the CTS pin.

8. Execute an EI instruction to enable interrupts.

The UART is now configured for interrupt-driven data transmission. Because the UART Transmit Data Register is empty, an interrupt is generated immediately. When the UART Transmit interrupt is detected, the associated interrupt service routine (ISR) performs the following:

1. Write the UART Control 1 Register to select the multiprocessor bit for the byte to be transmitted:
 Set the Multiprocessor Bit Transmitter (MPBT) if sending an address byte, clear it if sending a data byte.
2. Write the data byte to the UART Transmit Data Register. The transmitter automatically transfers the data to the Transmit Shift register and transmits the data.
3. Clear the UART Transmit interrupt bit in the applicable Interrupt Request register.
4. Execute the IRET instruction to return from the interrupt-service routine and wait for the Transmit Data Register to again become empty.

Receiving Data Using the Polled Method

Observe the following steps to configure the UART for polled data reception:

1. Write to the UART Baud Rate High and Low Byte registers to set an acceptable baud rate for the incoming data stream.
2. Enable the UART pin functions by configuring the associated GPIO port pins for alternate function operation.
3. Write to the UART Control 1 Register to enable MULTIPROCESSOR Mode functions, if appropriate.
4. Write to the UART Control 0 Register to:
 - Set the receive enable bit (REN) to enable the UART for data reception
 - Enable parity, if appropriate and if Multiprocessor mode is not enabled, and select either even or odd parity
5. Check the RDA bit in the UART Status 0 Register to determine if the Receive Data Register contains a valid data byte (indicated by a 1). If RDA is set to 1 to indicate available data, continue to [Step 6](#). If the Receive Data Register is empty (indicated by a 0), continue to monitor the RDA bit awaiting reception of the valid data.
6. Read data from the UART Receive Data Register. If operating in MULTIPROCESSOR (9-bit) Mode, further actions may be required depending on the MULTIPROCESSOR Mode bits MPMD[1:0].

1. Checks the UART Status 0 Register to determine the source of the interrupt - error, break, or received data.
2. Reads the data from the UART Receive Data Register if the interrupt was because of data available. If operating in MULTIPROCESSOR (9-bit) Mode, further actions may be required depending on the MULTIPROCESSOR Mode bits MPMD[1:0].
3. Clears the UART Receiver interrupt in the applicable Interrupt Request register.
4. Executes the IRET instruction to return from the interrupt-service routine and await more data.

Clear To Send ($\overline{\text{CTS}}$) Operation

The CTS pin, if enabled by the CTSE bit of the UART Control 0 Register, performs flow control on the outgoing transmit datastream. The Clear To Send ($\overline{\text{CTS}}$) input pin is sampled one system clock before beginning any new character transmission. To delay transmission of the next data character, an external receiver must deassert $\overline{\text{CTS}}$ at least one system clock cycle before a new data transmission begins. For multiple character transmissions, this action is typically performed during Stop Bit transmission. If $\overline{\text{CTS}}$ deasserts in the middle of a character transmission, the current character is sent completely.

MULTIPROCESSOR (9-Bit) Mode

The UART has a MULTIPROCESSOR (9-bit) Mode that uses an extra (9th) bit for selective communication when a number of processors share a common UART bus. In MULTIPROCESSOR Mode (also referred to as 9-bit mode), the multiprocessor bit (MP) is transmitted immediately following the 8-bits of data and immediately preceding the Stop bit(s) as displayed in Figure 13. The character format is given below:

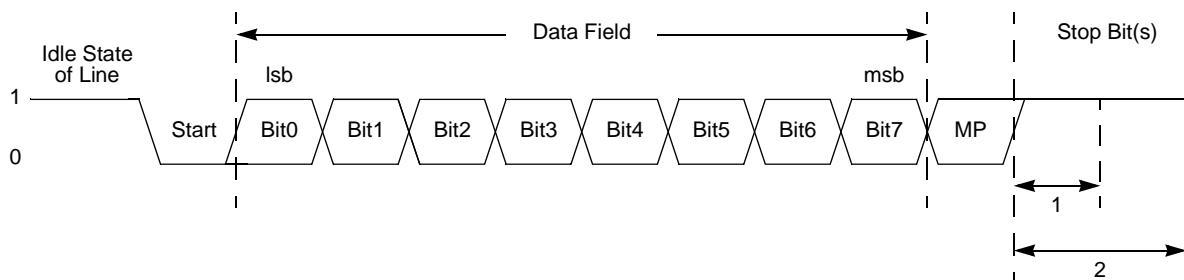


Figure 13. UART Asynchronous MULTIPROCESSOR Mode Data Format

In MULTIPROCESSOR (9-bit) Mode, the parity bit location (9th bit) becomes the Multiprocessor control bit. The UART Control 1 and Status 1 registers provide MULTIPROCESSOR (9-bit) Mode control and status information. If an automatic address matching

Analog-to-Digital Converter

The Analog-to-Digital Converter (ADC) converts an analog input signal to its digital representation. The features of this sigma-delta ADC include:

- 10-bit resolution
- Eight single-ended analog input sources are multiplexed with general-purpose I/O ports
- Interrupt upon conversion complete
- Bandgap generated internal voltage reference generator with two selectable levels
- Factory offset and gain calibration

Architecture

Figure 19 displays the major functional blocks of the ADC. An analog multiplexer network selects the ADC input from the available analog pins, ANA0 through ANA7.

Automatic Powerdown

If the ADC is idle (no conversions in progress) for 160 consecutive system clock cycles, portions of the ADC are automatically powered down. From this powerdown state, the ADC requires 40 system clock cycles to powerup. The ADC powers up when a conversion is requested by the ADC Control Register.

Single-Shot Conversion

When configured for single-shot conversion, the ADC performs a single analog-to-digital conversion on the selected analog input channel. After completion of the conversion, the ADC shuts down. Observe the following steps for setting up the ADC and initiating a single-shot conversion:

1. Enable the acceptable analog inputs by configuring the general-purpose I/O pins for alternate function. This configuration disables the digital input and output drivers.
2. Write the ADC Control/Status Register 1 to configure the ADC
 - Write the REFSELH bit of the pair {REFSELH, REFSELL} to select the internal voltage reference level or to disable the internal reference. The REFSELH bit is contained in the ADC Control/Status Register 1.
3. Write to the ADC Control Register 0 to configure the ADC and begin the conversion. The bit fields in the ADC Control Register can be written simultaneously:
 - Write to the ANAIN[3:0] field to select from the available analog input sources (different input pins available depending on the device).
 - Clear CONT to 0 to select a single-shot conversion.
 - If the internal voltage reference must be output to a pin, set the REFEXT bit to 1. The internal voltage reference must be enabled in this case.
 - Write the REFSELL bit of the pair {REFSELH, REFSELL} to select the internal voltage reference level or to disable the internal reference. The REFSELL bit is contained in the ADC Control Register 0.
 - Set CEN to 1 to start the conversion.
4. CEN remains 1 while the conversion is in progress. A single-shot conversion requires 5129 system clock cycles to complete. If a single-shot conversion is requested from an ADC powered-down state, the ADC uses 40 additional clock cycles to power-up before beginning the 5129 cycle conversion.
5. When the conversion is complete, the ADC control logic performs the following operations:
 - 11-bit two's-complement result written to {ADCD_H[7:0], ADCD_L[7:5]}

ADC Data High Byte Register

The ADC Data High Byte Register contains the upper eight bits of the ADC output. The output is an 11-bit two's complement value. During a single-shot conversion, this value is invalid. Access to the ADC Data High Byte register is read-only. Reading the ADC Data High Byte Register latches data in the ADC Low Bits Register.

Table 76. ADC Data High Byte Register (ADCD_H)

Bit	7	6	5	4	3	2	1	0
Field	ADCDH							
RESET	X	X	X	X	X	X	X	X
R/W	R	R	R	R	R	R	R	R
Address	F72H							

Bit	Description
[7:0]	ADC Data High Byte
ADCDH	This byte contains the upper eight bits of the ADC output. These bits are not valid during a single-shot conversion. During a continuous conversion, the most recent conversion output is held in this register. These bits are undefined after a Reset.

Page Erase

The Flash memory can be erased one page (512 bytes) at a time. Page Erasing the Flash memory sets all bytes in that page to the value FFH. The Flash Page Select register identifies the page to be erased. Only a page residing in an unprotected sector can be erased. With the Flash Controller unlocked and the active page set, writing the value 95h to the Flash Control Register initiates the Page Erase operation. While the Flash Controller executes the Page Erase operation, the eZ8 CPU idles but the system clock and on-chip peripherals continue to operate. The eZ8 CPU resumes operation after the Page Erase operation completes. If the Page Erase operation is performed using the On-Chip Debugger, poll the Flash Status Register to determine when the Page Erase operation is complete. When the Page Erase is complete, the Flash Controller returns to its locked state.

Mass Erase

The Flash memory can also be Mass Erased using the Flash Controller, but only by using the On-Chip Debugger. Mass Erasing the Flash memory sets all bytes to the value FFH. With the Flash Controller unlocked and the Mass Erase successfully enabled, writing the value 63H to the Flash Control Register initiates the Mass Erase operation. While the Flash Controller executes the Mass Erase operation, the eZ8 CPU idles but the system clock and on-chip peripherals continue to operate. Using the On-Chip Debugger, poll the Flash Status Register to determine when the Mass Erase operation is complete. When the Mass Erase is complete, the Flash Controller returns to its locked state.

Flash Controller Bypass

The Flash Controller can be bypassed and the control signals for the Flash memory brought out to the GPIO pins. Bypassing the Flash Controller allows faster Row Programming algorithms by controlling the Flash programming signals directly.

Row programming is recommended for gang programming applications and large volume customers who do not require in-circuit initial programming of the Flash memory. Page Erase operations are also supported when the Flash Controller is bypassed.

For more information about bypassing the Flash Controller, refer to the Zilog application note titled, Third-Party Flash Programming Support for Z8 Encore! MCUs (AN0117), available for download at www.zilog.com.

Flash Controller Behavior in DEBUG Mode

The following changes in behavior of the Flash Controller occur when the Flash Controller is accessed using the On-Chip Debugger:

- The Flash Write Protect option bit is ignored
- The Flash Sector Protect register is ignored for programming and erase operations

Table 81. Flash Control Register (FCTL)

Bit	7	6	5	4	3	2	1	0
Field	FCMD							
RESET	0	0	0	0	0	0	0	0
R/W	W	W	W	W	W	W	W	W
Address	FF8H							

Bit	Description
[7:0]	Flash Command
FCMD	73H = First unlock command. 8CH = Second unlock command. 95H = Page Erase command (must be third command in sequence to initiate Page Erase). 63H = Mass Erase command (must be third command in sequence to initiate Mass Erase). 5EH = Enable Flash Sector Protect Register Access.

Table 107. Assembly Language Syntax Example 2

Assembly Language Code	ADD	43H,	R8	(ADD dst, src)
Object Code	04	E8	43	(OPC src, dst)

See the device-specific Z8 Encore! XP Product Specification to determine the exact register file range available. The register file size varies, depending on the device type.

eZ8 CPU Instruction Notation

In the eZ8 CPU Instruction Summary and Description sections, the operands, condition codes, status flags, and address modes are represented by a notational shorthand that is noted in Table 108.

Table 108. Notational Shorthand

Notation	Description	Operand	Range
b	Bit	b	b represents a value from 0 to 7 (000B to 111B).
cc	Condition Code	—	See the Condition Codes overview in the eZ8 CPU Core User Manual (UM0128) .
DA	Direct Address	AddrS	AddrS represents a number in the range of 0000H to FFFFH.
ER	Extended Addressing Register	Reg	Reg represents a number in the range of 000H to FFFH.
IM	Immediate Data	#Data	Data is a number between 00H to FFH.
Ir	Indirect Working Register	@Rn	n = 0–15.
IR	Indirect Register	@Reg	Reg. represents a number in the range of 00H to FFH.
Irr	Indirect Working Register Pair	@RRp	p = 0, 2, 4, 6, 8, 10, 12, or 14.
IRR	Indirect Register Pair	@Reg	Reg represents an even number in the range 00H to FEH
p	Polarity	p	Polarity is a single bit binary value of either 0B or 1B.
r	Working Register	Rn	n = 0–15.
R	Register	Reg	Reg. represents a number in the range of 00H to FFH.

Table 135. Z8 Encore! XP F0823 Series Ordering Matrix (Continued)

Part Number	Flash	RAM	I/O Lines	Interrupts	16-Bit Timers w/PWM	10-Bit A/D Channels	UART with IrDA	Description
Z8 Encore! XP F0823 Series with 4 KB Flash								
Standard Temperature: 0°C to 70°C								
Z8F0413PB005SG	4 KB	1 KB	6	12	2	0	1	PDIP 8-pin package
Z8F0413QB005SG	4 KB	1 KB	6	12	2	0	1	QFN 8-pin package
Z8F0413SB005SG	4 KB	1 KB	6	12	2	0	1	SOIC 8-pin package
Z8F0413SH005SG	4 KB	1 KB	16	18	2	0	1	SOIC 20-pin package
Z8F0413HH005SG	4 KB	1 KB	16	18	2	0	1	SSOP 20-pin package
Z8F0413PH005SG	4 KB	1 KB	16	18	2	0	1	PDIP 20-pin package
Z8F0413SJ005SG	4 KB	1 KB	24	18	2	0	1	SOIC 28-pin package
Z8F0413HJ005SG	4 KB	1 KB	24	18	2	0	1	SSOP 28-pin package
Z8F0413PJ005SG	4 KB	1 KB	24	18	2	0	1	PDIP 28-pin package
Extended Temperature: -40°C to 105°C								
Z8F0413PB005EG	4 KB	1 KB	6	12	2	0	1	PDIP 8-pin package
Z8F0413QB005EG	4 KB	1 KB	6	12	2	0	1	QFN 8-pin package
Z8F0413SB005EG	4 KB	1 KB	6	12	2	0	1	SOIC 8-pin package
Z8F0413SH005EG	4 KB	1 KB	16	18	2	0	1	SOIC 20-pin package
Z8F0413HH005EG	4 KB	1 KB	16	18	2	0	1	SSOP 20-pin package
Z8F0413PH005EG	4 KB	1 KB	16	18	2	0	1	PDIP 20-pin package
Z8F0413SJ005EG	4 KB	1 KB	24	18	2	0	1	SOIC 28-pin package
Z8F0413HJ005EG	4 KB	1 KB	24	18	2	0	1	SSOP 28-pin package
Z8F0413PJ005EG	4 KB	1 KB	24	18	2	0	1	PDIP 28-pin package

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